

## **Technical Data Sheet**

## **Chip Infrared LED With Right Angle Lens**

### **SIR12-21C/TR8**

#### **Features**

- Small double-end package
- Low forward voltage
- Good spectral matching to Si photo detector
- Package in 8mm tape on 7" diameter reel
- Pb free
- The product itself will remain within RoHS compliant version.



### **Descriptions**

SIR12-21C/TR8 is an infrared emitting diode in miniature SMD package molded in a water clear plastic with right angle lens.

The device is spectrally matched with silicon photodiode and phototransistor.

## **Applications**

- Household Appliances
- Electric Appliances
- Smoke detector
- Floppy disk drive

#### **Device Selection Guide**

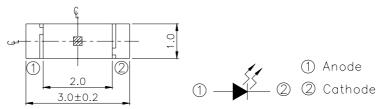
LED Part No.	Chip	Lens Color	
LED Part No.	Material		
SIR	GaAlAs	Water clear	

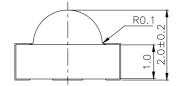
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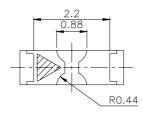


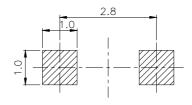
## **Package Dimensions**





For reflow soldering (propose)





**Notes:** 1.All dimensions are in millimeters

2.Tolerances unless dimensions ±0.1mm

## **Absolute Maximum Ratings (Ta=25°C)**

Parameter	Symbol	Rating	Units
Continuous Forward Current	$I_{\mathrm{F}}$	65	mA
Reverse Voltage	$V_R$	5	V
Operating Temperature	$T_{opr}$	-40 ~ +85	$^{\circ}\!\mathbb{C}$
Storage Temperature	$T_{stg}$	-40 ~ +85	$^{\circ}\!\mathbb{C}$
Soldering Temperature *1	$T_{sol}$	260	$^{\circ}$
Power Dissipation at(or below)	$P_d$	110	mW
25°C Free Air Temperature			

**Notes:** \*1. Soldering time  $\leq 5$  seconds.

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# Electro-Optical Characteristics (Ta=25 $^{\circ}$ C)

Parameter	Symbol	Condition	Min.	Typ.	Max.	Units	
		I <sub>F</sub> =20mA	0.5	0.9	-		
Radiant Intensity	Ee	$I_F = 100 mA$ Pulse Width $\leq 100 \mus$ ,Duty $\leq 1\%$		4		mW /sr	
Peak Wavelength	λp	I <sub>F</sub> =20mA		875		nm	
Spectral Bandwidth	Δλ	I <sub>F</sub> =20mA		80		nm	
		I <sub>F</sub> =20mA		1.3	1.6		
Forward Voltage	$V_{\mathrm{F}}$	$I_F = 100 mA$ Pulse Width $\leq 100 \mu  s$ , Duty $\leq 1\%$		1.4	1.8	V	
Reverse Current	$I_R$	$V_R=5V$			10	$\mu$ A	
View Angle	2 \theta 1/2	I <sub>F</sub> =20mA		160		deg	

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## **Typical Electro-Optical Characteristics Curves**

Fig.1 Forward Current vs.

Ambient Temperature

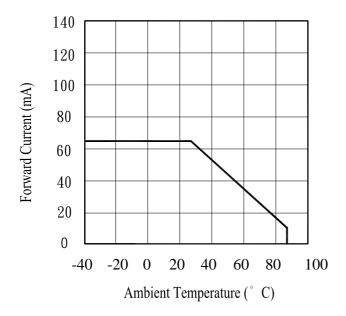


Fig.2 Spectral Distribution

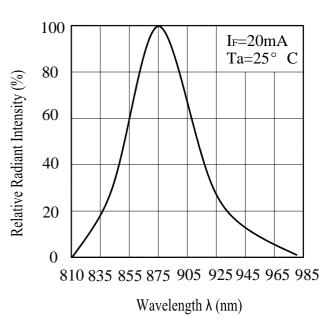


Fig.3 Peak Emission Wavelength
Ambient Temperature

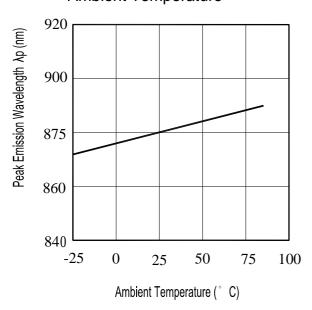
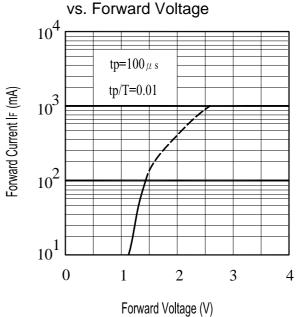


Fig.4 Forward Current



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## **Typical Electro-Optical Characteristics Curves**

Fig.5 Relative Intensity vs.

Forward Current

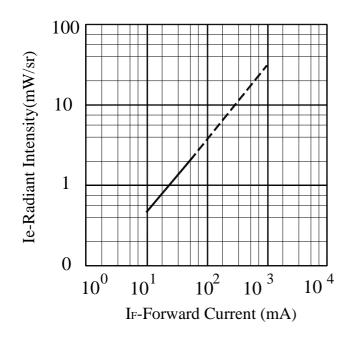


Fig.6 Relative Radiant Intensity vs.

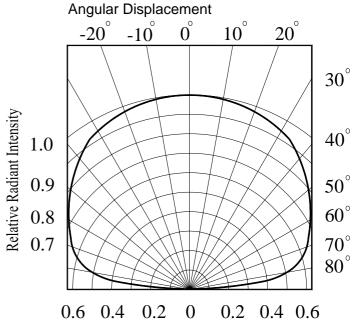


Fig.7 Relative Intensity vs.

Ambient Temperature(°C)

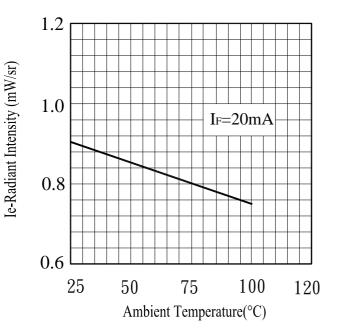
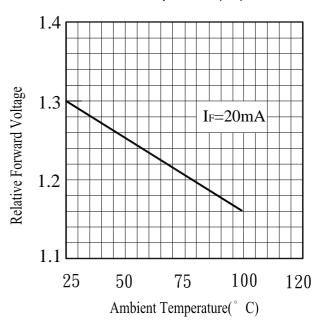


Fig.8 Forward Voltage vs.

Ambient Temperature(°C)



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#### **Precautions For Use**

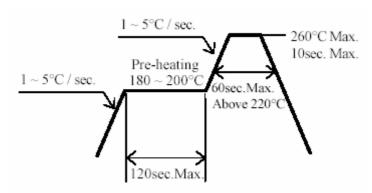
1. Over-current-proof

Customer must apply resistors for protection, otherwise slight voltage shift will cause big current change (Burn out will happen).

- 2. Storage
  - 2.1 Do not open moisture proof bag before the products are ready to use.
- 2.2 Before opening the package, the LEDs should be kept at 30°C or less and 90%RH or less.
- 2.3 The LEDs should be used within a year.
- 2.4 After opening the package, the LEDs should be kept at 30°C or less and 70%RH or less.
- 2.5 The LEDs should be used within 168 hours (7 days) after opening the package.
- 2.6 If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the following conditions.

Baking treatment :  $60\pm5^{\circ}$ C for 24 hours.

- 3. Soldering Condition
- 3.1 Pb-free solder temperature profile



- 3.2 Reflow soldering should not be done more than two times.
- 3.3 When soldering, do not put stress on the LEDs during heating.
- 3.4 After soldering, do not warp the circuit board.

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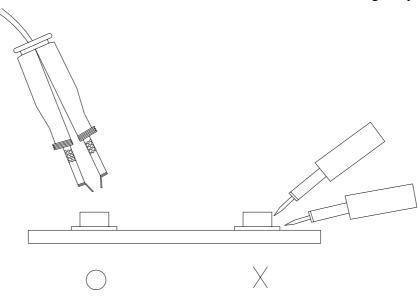


#### 4. Soldering Iron

Each terminal is to go to the tip of soldering iron temperature less than  $280^{\circ}$ C for 3 seconds within once in less than the soldering iron capacity 25W. Leave two seconds and more intervals, and do soldering of each terminal. Be careful because the damage of the product is often started at the time of the hand solder.

#### 5.Repairing

Repair should not be done after the LEDs have been soldered. When repairing is unavoidable, a double-head soldering iron should be used (as below figure). It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.



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## **Reliability Test Item And Condition**

The reliability of products shall be satisfied with items listed below.

Confidence level: 90%

LTPD: 10%

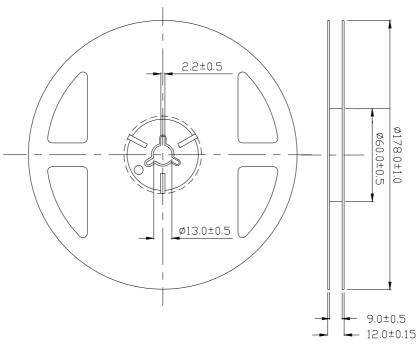
NO.	Item	Test Conditions	Test Hours/	Sample	Failure	Ac/Re
			Cycles	Sizes	Judgement	
					Criteria	
1	REFLOW Soldering	TEMP. : 260°C±5°C	6Mins	22pcs		0/1
		5secs			$I_R \ge U \times 2$	
2	Temperature Cycle	$H:+100^{\circ}C$ 15mins	50Cycles	22pcs	Ee≦Lx0.8	0/1
		5mins			$V_F \ge U \times 1.2$	
		L:-40°C 15mins				
3	Thermal Shock	H :+100°C	50Cycles	22pcs	U: Upper	0/1
		↓ 10secs			Specification	
		L:- $10^{\circ}$ C 5mins			Limit	
4	High Temperature	TEMP. ∶ +100°C	1000hrs	22pcs	L: Lower	0/1
	Storage				Specification	
5	Low Temperature	TEMP. : -40°C	1000hrs	22pcs	Limit	0/1
	Storage					
6	DC Operating Life	$I_F=20mA$	1000hrs	22pcs		0/1
7	High Temperature/	85°C /85% R.H	1000hrs	22pcs		0/1
	High Humidity					

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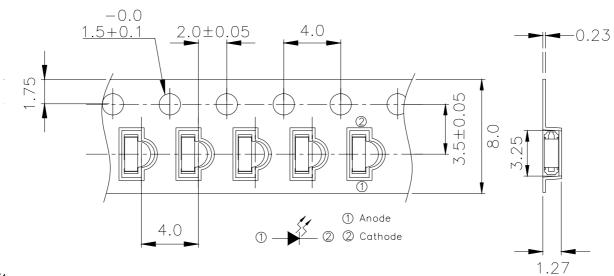


## **Package Dimensions**



## **Taping Dimensions**

# Progressive direction



#### **Unit:mm**

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### **Packing Quantity Specification**

1.2000Pcs/1Volume, 1Volume/1Bag

2.10Boxes/1Carton

### **Label Form Specification**



CPN: Customer's Production Number

P/N : Production Number

QTY: Packing Quantity

CAT: Ranks

HUE: Peak Wavelength

**REF:** Reference

LOT No: Lot Number

MADE IN TAIWAN: Production Place

#### **Notes**

- 1. Above specification may be changed without notice. EVERLIGHT will reserve authority on material change for above specification.
- 2. When using this product, please observe the absolute maximum ratings and the instructions for using outlined in these specification sheets. EVERLIGHT assumes no responsibility for any damage resulting from use of the product which does not comply with the absolute maximum ratings and the instructions included in these specification sheets.
- 3. These specification sheets include materials protected under copyright of EVERLIGHT corporation. Please don't reproduce or cause anyone to reproduce them without EVERLIGHT's consent.

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